Ultrafast Avalanche SMD Rectifier

SMA (DO-214AC)

FEATURES

- Low profile package
- Ideal for automated placement
- Glass passivated pellet chip junction
- Low reverse current
- High reverse voltage
- Ultra fast reverse recovery time
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

RoHS COMPLIANT
HALOGEN FREE

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	1.5 A
V_{RRM}	1000 V
I_{FSM}	30 A
I_R	5.0 µA
t_{rr}	75 ns
V_F	1.7 V
E_R	20 mJ
T_J max.	150 °C
Package	SMA (DO-214AC)
Diode variations	Single

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive, and telecommunication.

MECHANICAL DATA

Case: SMA (DO-214AC)
Molding compound meets UL 94 V-0 flammability rating
Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade
Base P/NHM3_X - halogen-free, RoHS-compliant, and AEC-Q101 qualified ("_X" denotes revision code e.g. A, B,...)

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102
M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes the cathode end

MAXIMUM RATINGS (T_A = 25 °C unless otherwise noted)			
PARAMETER	**SYMBOL**	**BYG23M**	**UNIT**
Device marking code		BYG23M	
Maximum repetitive peak reverse voltage	V_{RRM}	1000	V
Average forward current at T_A = 65 °C	$I_{F(AV)}$	1.5	A
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I_{FSM}	30	A
Pulse energy in avalanche mode, non repetitive (inductive load switch off) $I_{(BR)R}$ = 1 A, T_J = 25 °C	E_R	20	mJ
Operating junction and storage temperature range	T_J, T_{STG}	-55 to +150	°C

ELECTRICAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)					
PARAMETER	**TEST CONDITIONS**		**SYMBOL**	**BYG23M**	**UNIT**
Minimum breakdown voltage	I_R = 100 µA		V_{BR}	1000	V
Maximum instantaneous voltage	I_F = 1.0 A	T_J = 25 °C	V_F (1)	1.7	V
		T_J = 150 °C		1.35	
Maximum reverse current	$V_R = V_{RRM}$	T_J = 25 °C	I_R	5	µA
		T_J = 125 °C		50	
Maximum reverse recovery time	I_F = 0.5 A, I_R = 1.0 A, I_{rr} = 0.25 A		t_{rr}	75	ns

Note

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T_A = 25 °C unless otherwise noted)			
PARAMETER	**SYMBOL**	**BYG23M**	**UNIT**
Typical thermal resistance, junction to case	$R_{\theta JC}$	25	°C/W
Typical thermal resistance, junction to ambient	$R_{\theta JA}$ (1)	150	°C/W
	$R_{\theta JA}$ (2)	125	
	$R_{\theta JA}$ (3)	100	

Notes

(1) Mounted on epoxy-glass hard tissue, 17 mm^2 35 µm Cu
(2) Mounted on epoxy-glass hard tissue, 50 mm^2 35 µm Cu
(3) Mounted on Al-oxide-ceramic (Al_2O_3), 50 mm^2 35 µm Cu

ORDERING INFORMATION (Example)				
PREFERRED P/N	**UNIT WEIGHT (g)**	**PREFERRED PACKAGE CODE**	**BASE QUANTITY**	**DELIVERY MODE**
BYG23M-M3/TR	0.064	TR	1800	7" diameter plastic tape and reel
BYG23M-M3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel
BYG23MHM3_A/H (1)	0.064	H	1800	7" diameter plastic tape and reel
BYG23MHM3_A/I (1)	0.064	I	7500	13" diameter plastic tape and reel

Note

(1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

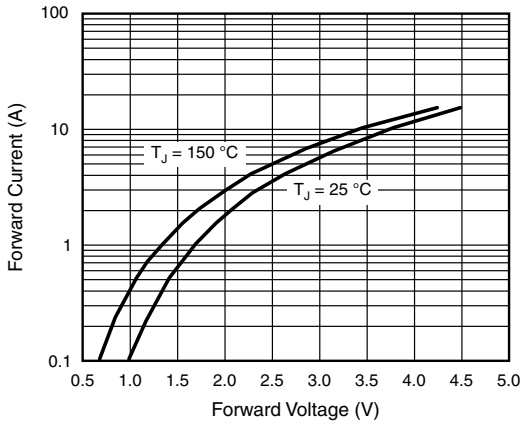


Fig. 1 - Max. Forward Current vs. Forward Voltage

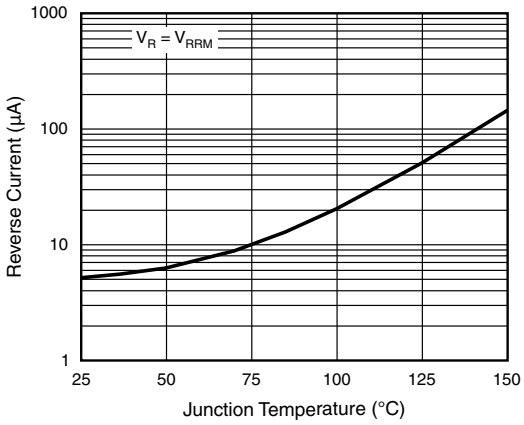


Fig. 4 - Reverse Current vs. Junction Temperature

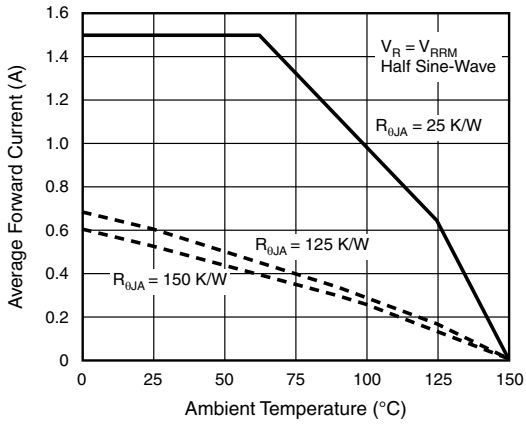


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature

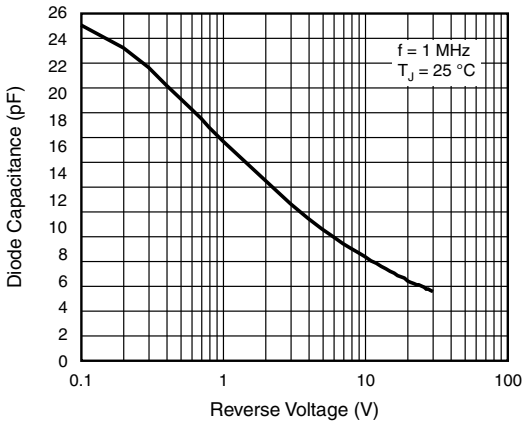


Fig. 5 - Diode Capacitance vs. Reverse Voltage

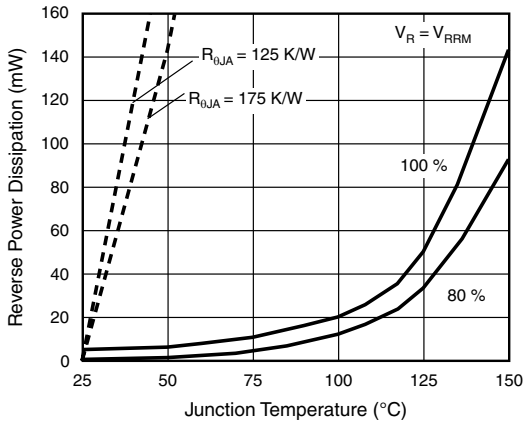
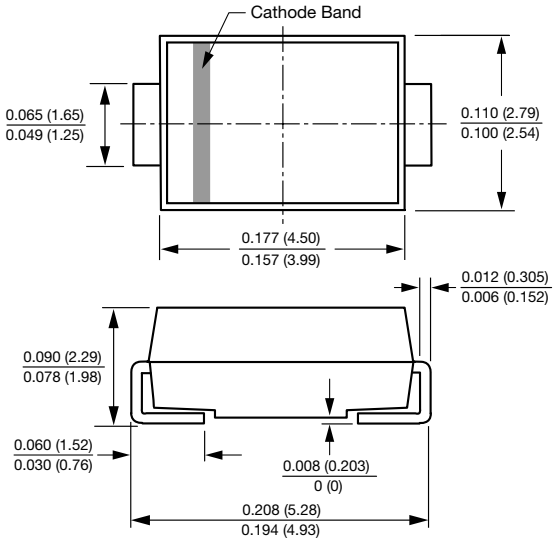


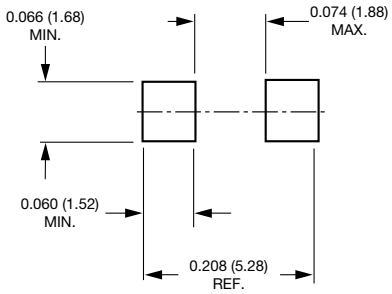
Fig. 3 - Max. Reverse Power Dissipation vs. Junction Temperature

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SMA (DO-214AC)



Mounting Pad Layout



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